

March 1995

Features

- Drives N-Channel FET Full Bridge Including High Side Chop Capability
- Bootstrap Supply Max Voltage to 95VDC
- Drives 1000pF Load at 1MHz in Free Air at +50°C with Rise and Fall Times of Typically 10ns
- User-Programmable Dead Time
- Charge-Pump and Bootstrap Maintain Upper Bias Supplies
- DIS (Disable) Pin Pulls Gates Low
- Input Logic Thresholds Compatible with 5V to 15V Logic Levels
- Very Low Power Consumption
- Undervoltage Protection

Applications

- Medium/Large Voice Coil Motors
- Full Bridge Power Supplies
- Class D Audio Power Amplifiers
- High Performance Motor Controls
- Noise Cancellation Systems
- Battery Powered Vehicles
- Peripherals
- U.P.S.

Description

The HIP4080A is a high frequency, medium voltage Full Bridge N-Channel FET driver IC, available in 20 lead plastic SOIC and DIP packages. The HIP4080A includes an input comparator, used to facilitate the "hysteresis" and PWM modes of operation. Its HEN (high enable) lead can force current to freewheel in the bottom two external power MOSFETs, maintaining the upper power MOSFETs off. Since it can switch at frequencies up to 1MHz, the HIP4080A is well suited for driving Voice Coil Motors, switching amplifiers in class D high-frequency switching audio amplifiers and power supplies.

HIP4080A can also drive medium voltage brush motors, and two HIP4080As can be used to drive high performance stepper motors, since the short minimum "on-time" can provide fine micro-stepping capability.

Short propagation delays of approximately 55ns maximizes control loop crossover frequencies and dead-times which can be adjusted to near zero to minimize distortion, resulting in precise control of the driven load.

The similar HIP4081A IC allows independent control of all 4 FETs in an Full Bridge configuration.

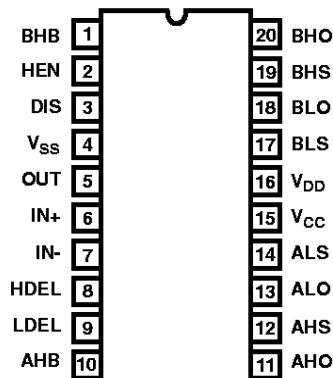
The Application Note for the HIP4080A is AN9404.

Ordering Information

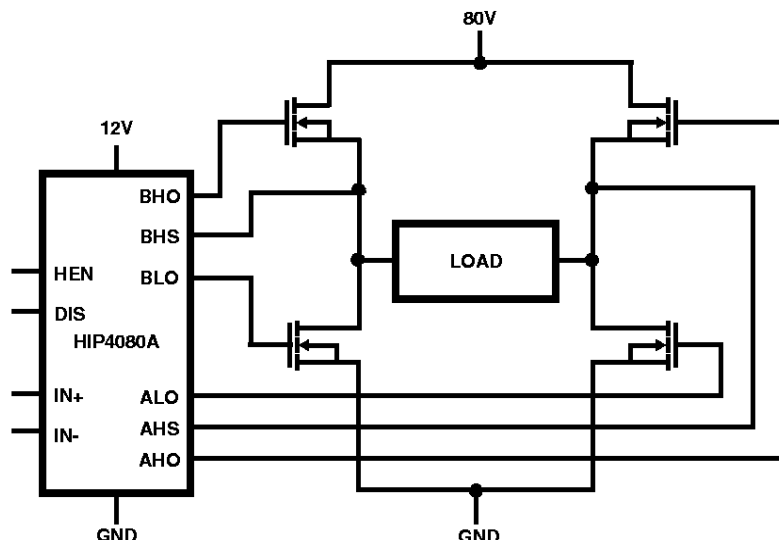
| PART NUMBER | TEMPERATURE RANGE | PACKAGE |
|-------------|-------------------|--------------------------|
| HIP4080AIP | -40°C to +85°C | 20 Lead Plastic DIP |
| HIP4080AIB | -40°C to +85°C | 20 Lead Plastic SOIC (W) |

Pinout

HIP4080A (PDIP, SOIC)
TOP VIEW



Application Block Diagram



Specifications HIP4080A

Absolute Maximum Ratings

Supply Voltage, V_{DD} and V_{CC} -0.3V to 16V
 Logic I/O Voltages -0.3V to $V_{DD} + 0.3V$
 Voltage on AHS, BHS -6.0V (Transient) to 80V (25°C to 125°C)
 Voltage on AHS, BHS -6.0V (Transient) to 70V (-55°C to 125°C)
 Voltage on ALS, BLS -2.0V (Transient) to +2.0V (Transient)
 Voltage on AHB, BHB $V_{AHS, BHS} - 0.3V$ to $V_{AHS, BHS} + V_{DD}$
 Voltage on ALO, BLO $V_{ALS, BLS} - 0.3V$ to $V_{CC} + 0.3V$
 Voltage on AHO, BHO $V_{AHS, BHS} - 0.3V$ to $V_{AHB, BHB} + 0.3V$
 Input Current, HDEL and LDEL -5mA to 0mA
 Phase Slew Rate 20V/ns
 NOTE: All Voltages relative to V_{SS} , unless otherwise specified.

Thermal Information

Thermal Resistance θ_{JA}
 SOIC Package +85°C/W
 DIP Package +75°C/W
 Maximum Power Dissipation at +85°C
 SOIC Package 470mW
 DIP Package 530mW
 Storage Temperature Range -65°C to +150°C
 Operating Max. Junction Temperature +125°C
 Lead Temperature (Soldering 10s) +300°C
 (For SOIC - Lead Tips Only)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Operating Conditions

Supply Voltage, V_{DD} and V_{CC} +9.5V to +15V
 Voltage on ALS, BLS -1.0V to +1.0V
 Voltage on AHB, BHB $V_{AHS, BHS} + 5V$ to $V_{AHS, BHS} + 15V$
 Input Current, HDEL and LDEL -500µA to -50µA
 Operating Ambient Temperature Range -40°C to +85°C

Electrical Specifications $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 100K$, and $T_A = +25^\circ C$, Unless Otherwise Specified

| PARAMETERS | SYMBOL | TEST CONDITIONS | $T_J = +25^\circ C$ | | | $T_J = -40^\circ C$ TO $+125^\circ C$ | | UNITS |
|--|--|---|---------------------|------|----------------|--|----------------|-------|
| | | | MIN | TYP | MAX | MIN | MAX | |
| SUPPLY CURRENTS AND CHARGE PUMPS | | | | | | | | |
| V_{DD} Quiescent Current | I_{DD} | IN- = 2.5V, Other Inputs = 0V | 8 | 11 | 14 | 7 | 14 | mA |
| V_{DD} Operating Current | I_{DDO} | Outputs switching f = 500kHz, No Load | 9 | 12 | 15 | 8 | 15 | mA |
| V_{CC} Quiescent Current | I_{CC} | IN- = 2.5V, Other Inputs = 0V, $I_{ALO} = I_{BLO} = 0$ | - | 25 | 80 | - | 100 | µA |
| V_{CC} Operating Current | I_{CCO} | f = 500kHz, No Load | 1 | 1.25 | 2.0 | 0.8 | 3 | mA |
| AHB, BHB Quiescent Current - Qpump Output Current | I_{AHB}, I_{BHB} | IN- = 2.5V, Other Inputs = 0V, $I_{AHO} =$ $I_{BHO} = 0$, $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 10V$ | -50 | -25 | -11 | -60 | -10 | µA |
| AHB, BHB Operating Current | I_{AHBO}, I_{BHBO} | f = 500kHz, No Load | 0.62 | 1.2 | 1.5 | 0.5 | 1.9 | mA |
| AHS, BHS, AHB, BHB Leakage Current | I_{HLK} | $V_{BHS} = V_{AHS} = 80V$, $V_{AHB} = V_{BHB} = 93V$ | - | 0.02 | 1.0 | - | 10 | µA |
| AHB-AHS, BHB-BHS Qpump Output Voltage | $V_{AHB} - V_{AHS}$ $V_{BHB} - V_{BHS}$ | $I_{AHB} = I_{AHS} = 0$, No Load | 11.5 | 12.6 | 14.0 | 10.5 | 14.5 | V |
| INPUT COMPARATOR PINS: IN+, IN-, OUT | | | | | | | | |
| Offset Voltage | V_{OS} | Over Common Mode Voltage Range | -10 | 0 | +10 | -15 | +15 | mV |
| Input Bias Current | I_{IB} | | 0 | 0.5 | 2 | 0 | 4 | µA |
| Input Offset Current | I_{OS} | | -1 | 0 | +1 | -2 | +2 | µA |
| Input Common Mode Voltage Range | CMVR | | 1 | - | $V_{DD} - 1.5$ | 1 | $V_{DD} - 1.5$ | V |
| Voltage Gain | AVOL | | 10 | 25 | - | 10 | - | V/mV |
| OUT High Level Output Voltage | V_{OH} | IN+ > IN-, $I_{OH} = -250\mu A$ | $V_{DD} - 0.4$ | - | - | $V_{DD} - 0.5$ | - | V |
| OUT Low Level Output Voltage | V_{OL} | IN+ < IN-, $I_{OL} = +250\mu A$ | - | - | 0.4 | - | 0.5 | V |
| Low Level Output Current | I_{OL} | $V_{OUT} = 6V$ | 6.5 | 14 | 19 | 6 | 20 | mA |
| High Level Output Current | I_{OH} | $V_{OUT} = 6V$ | -17 | -10 | -3 | -20 | -2.5 | mA |
| INPUT PINS: DIS | | | | | | | | |
| Low Level Input Voltage | V_{IL} | Full Operating Conditions | - | - | 1.0 | - | 0.8 | V |
| High Level Input Voltage | V_{IH} | Full Operating Conditions | 2.5 | - | - | 2.7 | - | V |
| Input Voltage Hysteresis | | | - | 35 | - | - | - | mV |
| Low Level Input Current | I_{IL} | $V_{IN} = 0V$, Full Operating Conditions | -130 | -100 | -75 | -135 | -65 | µA |
| High Level Input Current | I_{IH} | $V_{IN} = 5V$, Full Operating Conditions | -1 | - | +1 | -10 | +10 | µA |

Specifications HIP4080A

Electrical Specifications $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 100K$, and $T_A = +25^\circ C$, Unless Otherwise Specified **(Continued)**

| PARAMETERS | SYMBOL | TEST CONDITIONS | $T_J = +25^\circ C$ | | | $T_J = -40^\circ C$ TO $+125^\circ C$ | | UNITS |
|---|-------------------|---|---------------------|------|------|--|------|---------|
| | | | MIN | TYP | MAX | MIN | MAX | |
| INPUT PINS: HEN | | | | | | | | |
| Low Level Input Voltage | V_{IL} | Full Operating Conditions | - | - | 1.0 | - | 0.8 | V |
| High Level Input Voltage | V_{IH} | Full Operating Conditions | 2.5 | - | - | 2.7 | - | V |
| Input Voltage Hysteresis | | | - | 35 | - | - | - | mV |
| Low Level Input Current | I_{IL} | $V_{IN} = 0V$, Full Operating Conditions | -260 | -200 | -150 | -270 | -130 | μA |
| High Level Input Current | I_{IH} | $V_{IN} = 5V$, Full Operating Conditions | -1 | - | +1 | -10 | +10 | μA |
| TURN-ON DELAY PINS: LDEL AND HDEL | | | | | | | | |
| LDEL, HDEL Voltage | V_{HDEL} , V | $I_{HDEL} = I_{LDEL} = -100\mu A$ | 4.9 | 5.1 | 5.3 | 4.8 | 5.4 | V |
| GATE DRIVER OUTPUT PINS: ALO, BLO, AHO, AND BHO | | | | | | | | |
| Low Level Output Voltage | V_{OL} | $I_{OUT} = 100mA$ | 0.7 | 0.85 | 1.0 | 0.5 | 1.1 | V |
| High Level Output Voltage | $V_{CC} - V_{OH}$ | $I_{OUT} = -100mA$ | 0.8 | 0.95 | 1.1 | 0.5 | 1.2 | V |
| Peak Pullup Current | I_{O+} | $V_{OUT} = 0V$ | 1.7 | 2.6 | 3.8 | 1.4 | 4.1 | A |
| Peak Pulldown Current | I_{O-} | $V_{OUT} = 12V$ | 1.7 | 2.4 | 3.3 | 1.3 | 3.6 | A |
| Under Voltage, Rising Threshold | UV+ | | 8.1 | 8.8 | 9.4 | 8.0 | 9.5 | V |
| Under Voltage, Falling Threshold | UV- | | 7.6 | 8.3 | 8.9 | 7.5 | 9.0 | V |
| Under Voltage, Hysteresis | HYS | | 0.25 | 0.4 | 0.65 | 0.2 | 0.7 | V |

Switching Specifications $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 10K$, $C_L = 1000pF$, and $T_A = +25^\circ C$, Unless Otherwise Specified

| PARAMETERS | SYMBOL | TEST CONDITIONS | $T_J = +25^\circ C$ | | | $T_J = -40^\circ C$ TO $+125^\circ C$ | | UNITS |
|--|----------------|-----------------------------|---------------------|-----|-----|--|-----|-------|
| | | | MIN | TYP | MAX | MIN | MAX | |
| Lower Turn-off Propagation Delay (IN+/IN- to ALO/BLO) | T_{LPHL} | | - | 40 | 70 | - | 90 | ns |
| Upper Turn-off Propagation Delay (IN+/IN- to AHO/BHO) | T_{HPHL} | | - | 50 | 80 | - | 110 | ns |
| Lower Turn-on Propagation Delay (IN+/IN- to ALO/BLO) | T_{LPLH} | | - | 40 | 70 | - | 90 | ns |
| Upper Turn-on Propagation Delay (IN+/IN- to AHO/BHO) | T_{HPLH} | | - | 70 | 110 | - | 140 | ns |
| Rise Time | T_R | | - | 10 | 25 | - | 35 | ns |
| Fall Time | T_F | | - | 10 | 25 | - | 35 | ns |
| Turn-on Input Pulse Width | $T_{PWIN-ON}$ | | 50 | - | - | 50 | - | ns |
| Turn-off Input Pulse Width | $T_{PWIN-OFF}$ | | 40 | - | - | 40 | - | ns |
| Disable Turn-off Propagation Delay (DIS - Lower Outputs) | T_{DISLOW} | | - | 45 | 75 | - | 95 | ns |
| Disable Turn-off Propagation Delay (DIS - Upper Outputs) | $T_{DISHIGH}$ | | - | 55 | 85 | - | 105 | ns |
| Disable to Lower Turn-on Propagation Delay (DIS - ALO and BLO) | T_{DLPLH} | | - | 45 | 70 | - | 90 | ns |
| Refresh Pulse Width (ALO and BLO) | T_{REF-PW} | | 240 | 380 | 500 | 200 | 600 | ns |
| Disable to Upper Enable (DIS - AHO and BHO) | T_{UEN} | | - | 480 | 630 | - | 750 | ns |
| HEN-AHO, BHO Turn-off, Propagation Delay | $T_{HEN-PHL}$ | $R_{HDEL} = R_{LDEL} = 10K$ | - | 40 | 70 | - | 90 | ns |
| HEN-AHO, BHO Turn-on, Propagation Delay | $T_{HEN-PLH}$ | $R_{HDEL} = R_{LDEL} = 10K$ | - | 60 | 90 | - | 110 | ns |

TRUTH TABLE

| INPUT | | | | OUTPUT | | | |
|-----------|-----|-----|-----|--------|-----|-----|-----|
| IN+ > IN- | HEN | U/V | DIS | ALO | AHO | BLO | BHO |
| X | X | X | 1 | 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 |
| 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 |
| 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| X | X | 1 | X | 0 | 0 | 0 | 0 |

HIP4080A

Pin Descriptions

| PIN NUMBER | SYMBOL | DESCRIPTION |
|------------|-----------------|--|
| 1 | BHB | B High-side Bootstrap supply. External bootstrap diode and capacitor are required. Connect cathode of bootstrap diode and positive side of bootstrap capacitor to this pin. Internal charge pump supplies 30 μ A out of this pin to maintain bootstrap supply. Internal circuitry clamps the bootstrap supply to approximately 12.8V. |
| 2 | HEN | High-side Enable input. Logic level input that when low overrides IN+/IN- (Pins 6 and 7) to put AHO and BHO drivers (Pins 11 and 20) in low output state. When HEN is high AHO and BHO are controlled by IN+/IN- inputs. The pin can be driven by signal levels of 0V to 15V (no greater than V _{DD}). An internal 100 μ A pull-up to V _{DD} will hold HEN high, so no connection is required if high-side and low-side outputs are to be controlled by IN+/IN- inputs. |
| 3 | DIS | DISable input. Logic level input that when taken high sets all four outputs low. DIS high overrides all other inputs. When DIS is taken low the outputs are controlled by the other inputs. The pin can be driven by signal levels of 0V to 15V (no greater than V _{DD}). An internal 100 μ A pull-up to V _{DD} will hold DIS high if this pin is not driven. |
| 4 | V _{SS} | Chip negative supply, generally will be ground. |
| 5 | OUT | OUTput of the input control comparator. This output can be used for feedback and hysteresis. |
| 6 | IN+ | Noninverting input of control comparator. If IN+ is greater than IN- (Pin 7) then ALO and BHO are low level outputs and BLO and AHO are high level outputs. If IN+ is less than IN- then ALO and BHO are high level outputs and BLO and AHO are low level outputs. DIS (Pin 3) high level will override IN+/IN- control for all outputs. HEN (Pin 2) low level will override IN+/IN- control of AHO and BHO. When switching in four quadrant mode, dead time in a half bridge leg is controlled by HDEL and LDEL (Pins 8 and 9). |
| 7 | IN- | Inverting input of control comparator. See IN+ (Pin 6) description. |
| 8 | HDEL | High-side turn-on DELay. Connect resistor from this pin to V _{SS} to set timing current that defines the turn-on delay of both high-side drivers. The low-side drivers turn-off with no adjustable delay, so the HDEL resistor guarantees no shoot-through by delaying the turn-on of the high-side drivers. HDEL reference voltage is approximately 5.1V. |
| 9 | LDEL | Low-side turn-on DELay. Connect resistor from this pin to V _{SS} to set timing current that defines the turn-on delay of both low-side drivers. The high-side drivers turn-off with no adjustable delay, so the LDEL resistor guarantees no shoot-through by delaying the turn-on of the low-side drivers. LDEL reference voltage is approximately 5.1V. |
| 10 | AHB | A High-side Bootstrap supply. External bootstrap diode and capacitor are required. Connect cathode of bootstrap diode and positive side of bootstrap capacitor to this pin. Internal charge pump supplies 30 μ A out of this pin to maintain bootstrap supply. Internal circuitry clamps the bootstrap supply to approximately 12.8V. |
| 11 | AHO | A High-side Output. Connect to gate of A High-side power MOSFET. |
| 12 | AHS | A High-side Source connection. Connect to source of A High-side power MOSFET. Connect negative side of bootstrap capacitor to this pin. |
| 13 | ALO | A Low-side Output. Connect to gate of A Low-side power MOSFET. |
| 14 | ALS | A Low-side Source connection. Connect to source of A Low-side power MOSFET. |
| 15 | V _{CC} | Positive supply to gate drivers. Must be same potential as V _{DD} (Pin 16). Connect to anodes of two bootstrap diodes. |
| 16 | V _{DD} | Positive supply to lower gate drivers. Must be same potential as V _{CC} (Pin 15). De-couple this pin to V _{SS} (Pin 4). |
| 17 | BLS | B Low-side Source connection. Connect to source of B Low-side power MOSFET. |
| 18 | BLO | B Low-side Output. Connect to gate of B Low-side power MOSFET. |
| 19 | BHS | B High-side Source connection. Connect to source of B High-side power MOSFET. Connect negative side of bootstrap capacitor to this pin. |
| 20 | BHO | B High-side Output. Connect to gate of B High-side power MOSFET. |

Timing Diagrams

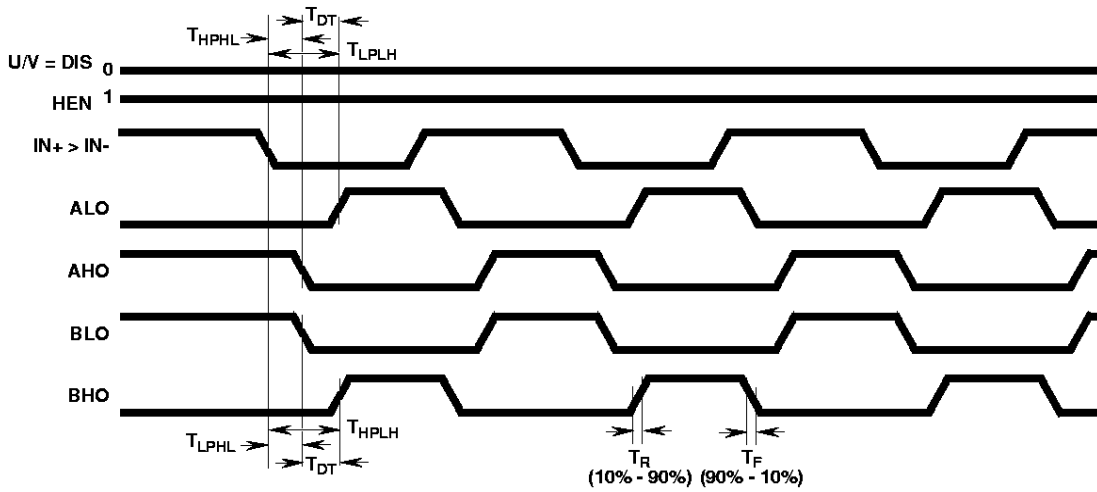


FIGURE 1. BISTATE MODE

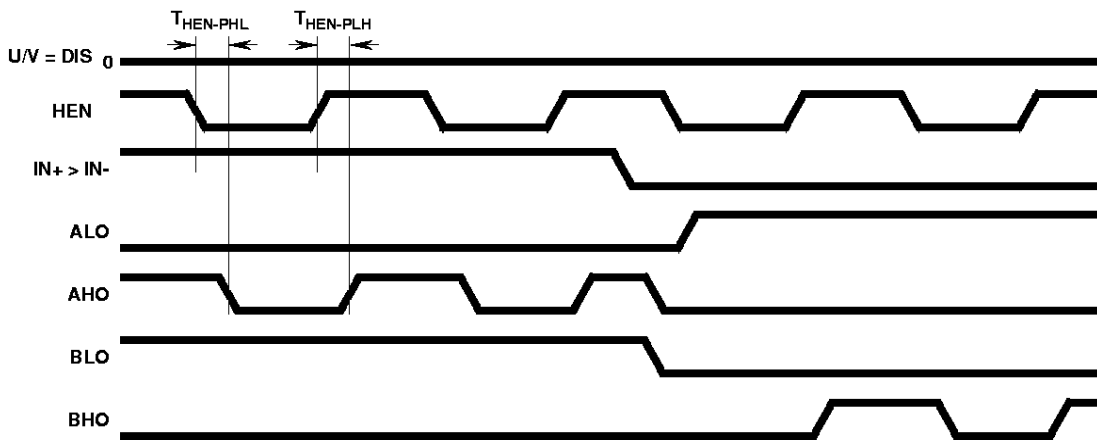


FIGURE 2. HIGH SIDE CHOP MODE

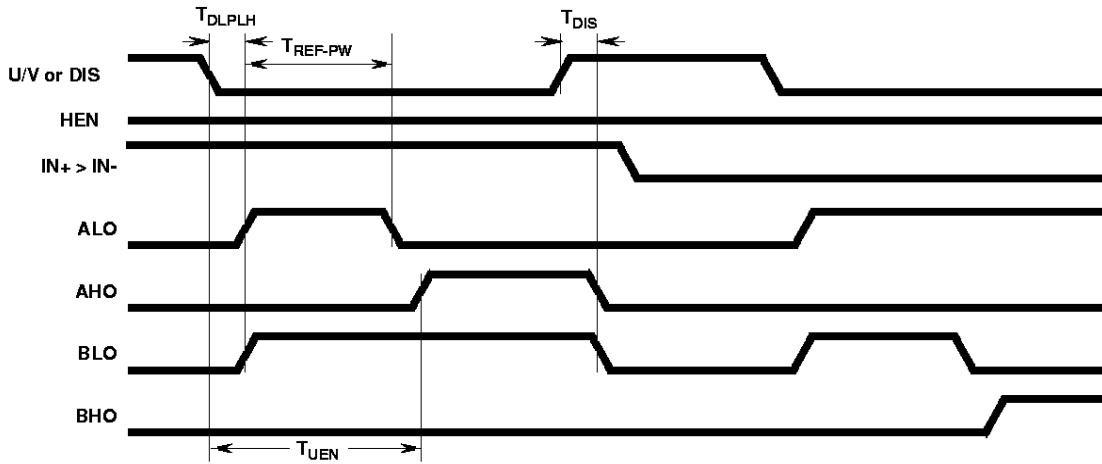


FIGURE 3. DISABLE FUNCTION

HIP4080A

Typical Performance Curves $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 100K$, and $T_A = +25^\circ C$, Unless Otherwise Specified

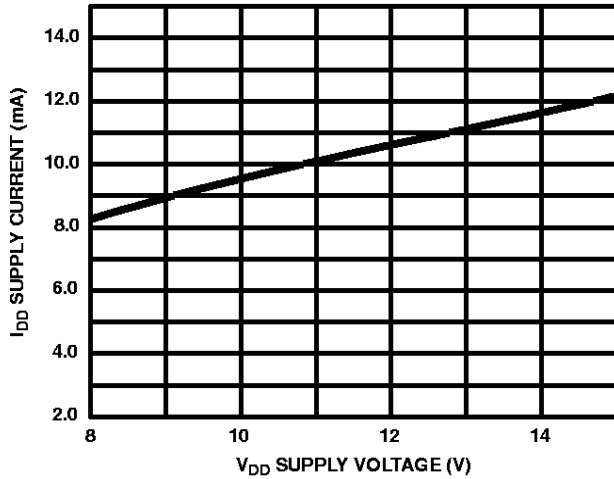


FIGURE 4. QUIESCENT I_{DD} SUPPLY CURRENT vs V_{DD} SUPPLY VOLTAGE

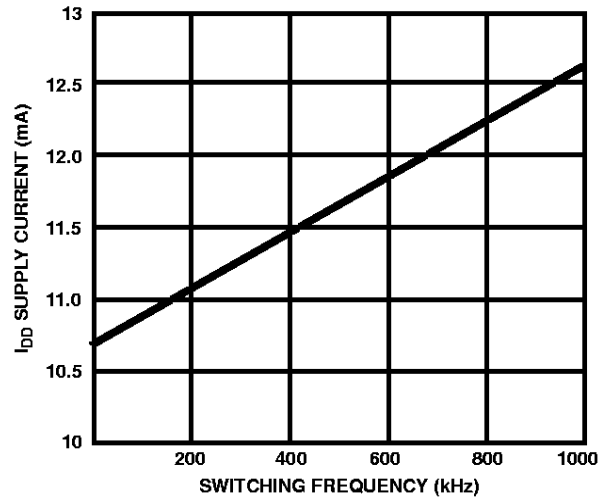


FIGURE 5. I_{DD0} NO-LOAD I_{DD} SUPPLY CURRENT vs FREQUENCY (kHz)

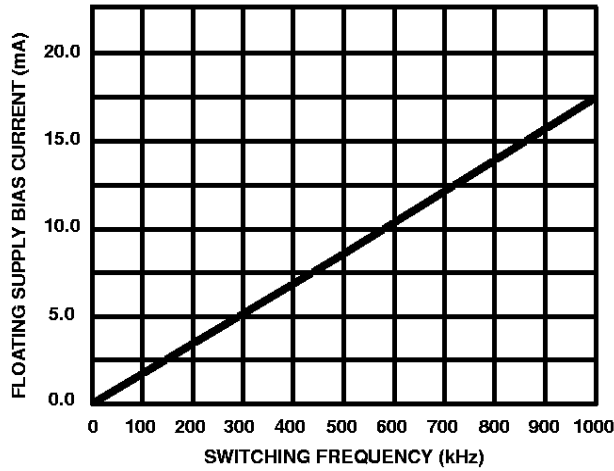


FIGURE 6. SIDE A, B FLOATING SUPPLY BIAS CURRENT vs FREQUENCY (LOAD = 1000pF)

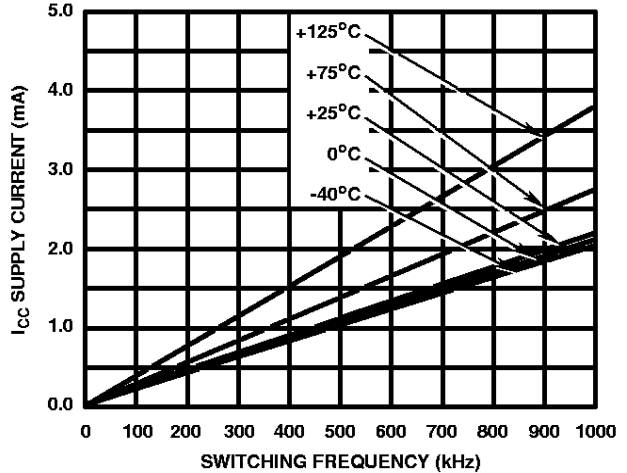


FIGURE 7. I_{CC0}, NO-LOAD I_{CC} SUPPLY CURRENT vs FREQUENCY (kHz) TEMPERATURE

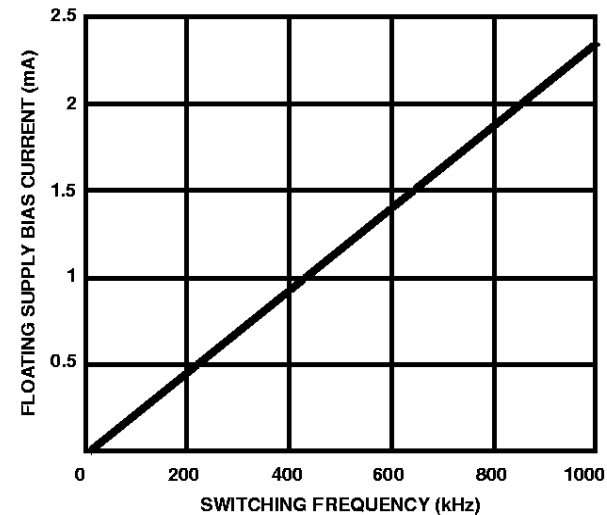


FIGURE 8. I_{AHB}, I_{BHB} NO-LOAD FLOATING SUPPLY BIAS CURRENT vs FREQUENCY

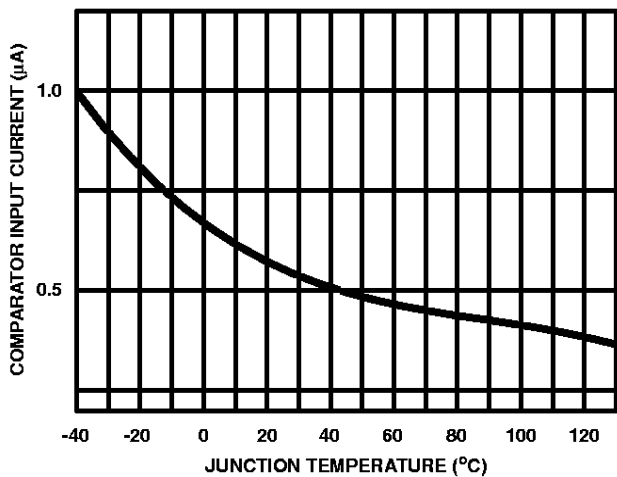


FIGURE 9. COMPARATOR INPUT CURRENT I_L vs TEMPERATURE AT V_{CM} = 5 V

HIP4080A

Typical Performance Curves $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 100K$, and $T_A = +25^{\circ}C$, Unless Otherwise Specified (Continued)

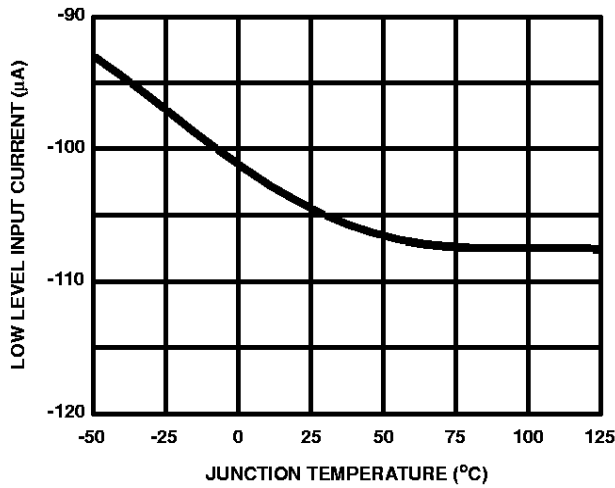


FIGURE 10. DIS LOW LEVEL INPUT CURRENT I_{IL} vs TEMPERATURE

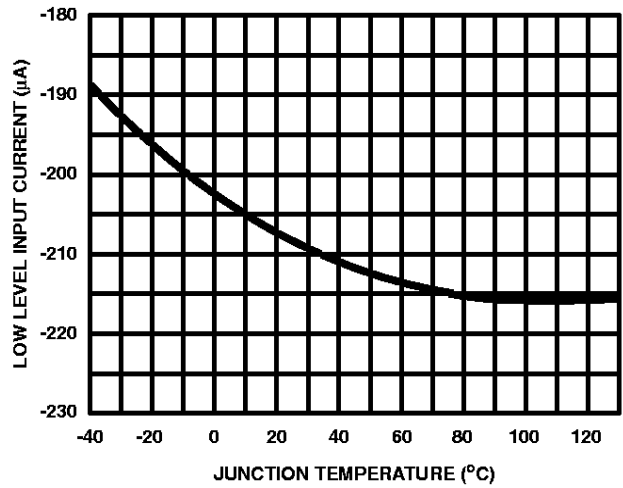


FIGURE 11. HEN LOW LEVEL INPUT CURRENT I_{IL} vs TEMPERATURE

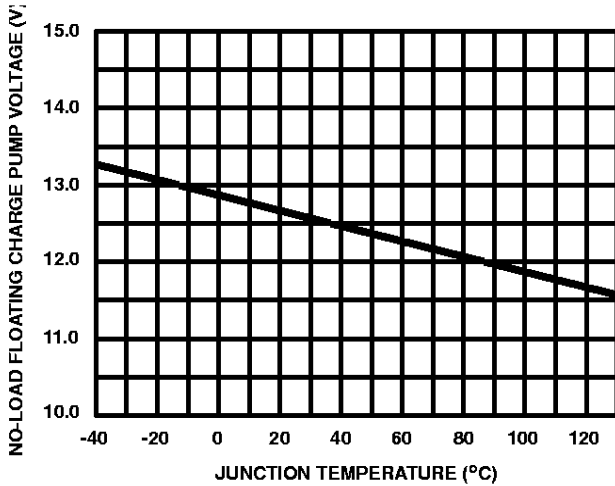


FIGURE 12. AHB - AHS, BHB - BHS NO-LOAD CHARGE PUMP VOLTAGE vs TEMPERATURE

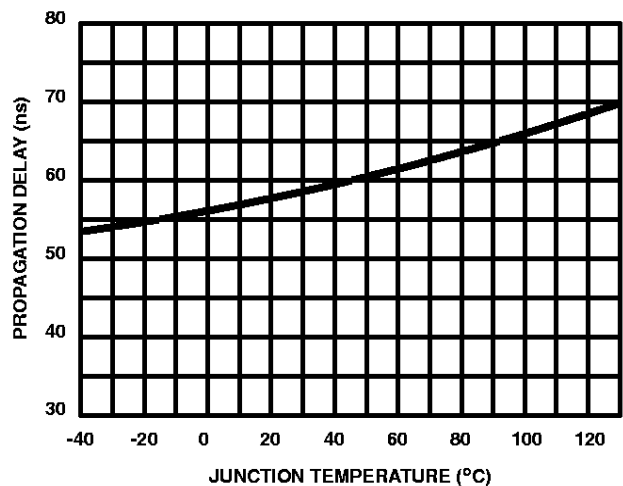


FIGURE 13. UPPER DISABLE TURN-OFF PROPAGATION DELAY $T_{DISHIGH}$ vs TEMPERATURE

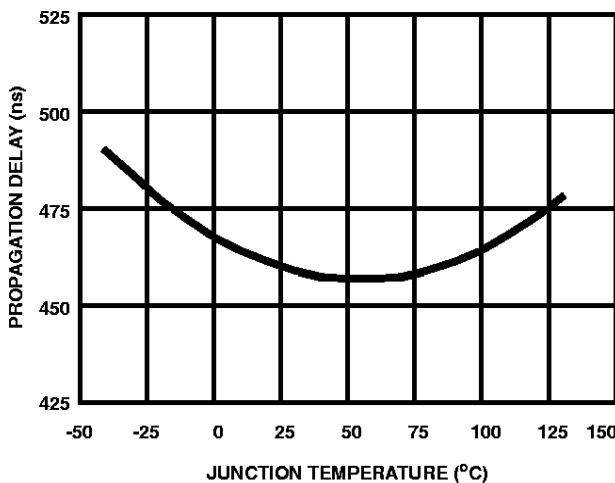


FIGURE 14. DISABLE TO UPPER ENABLE T_{UEN} PROPAGATION DELAY vs TEMPERATURE

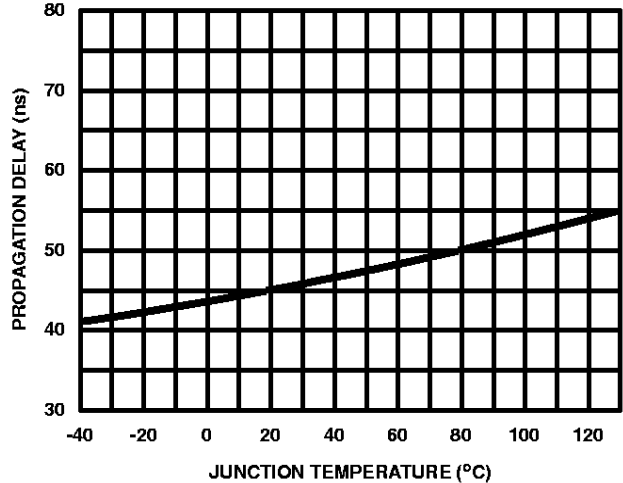


FIGURE 15. LOWER DISABLE TURN-OFF PROPAGATION DELAY T_{DISLOW} vs TEMPERATURE

HIP4080A

Typical Performance Curves $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 10K$, and $T_A = +25^\circ C$, Unless Otherwise Specified

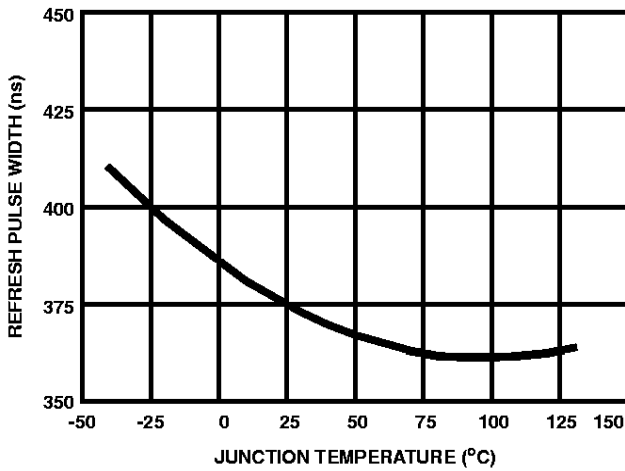


FIGURE 16. T_{REF-PW} REFRESH PULSE WIDTH vs TEMPERATURE

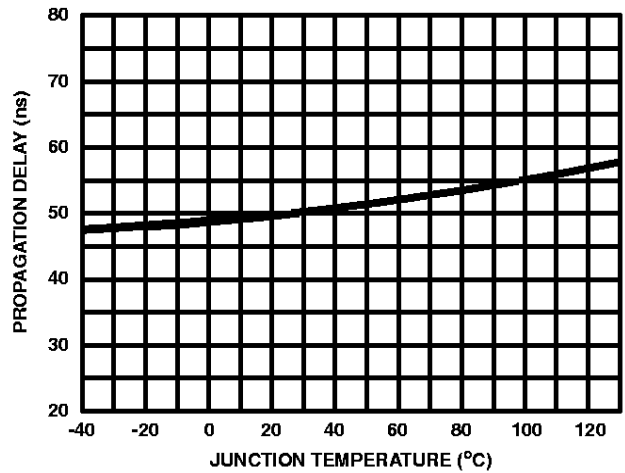


FIGURE 17. DISABLE TO LOWER ENABLE T_{DLPLH} PROPAGATION DELAY vs TEMPERATURE

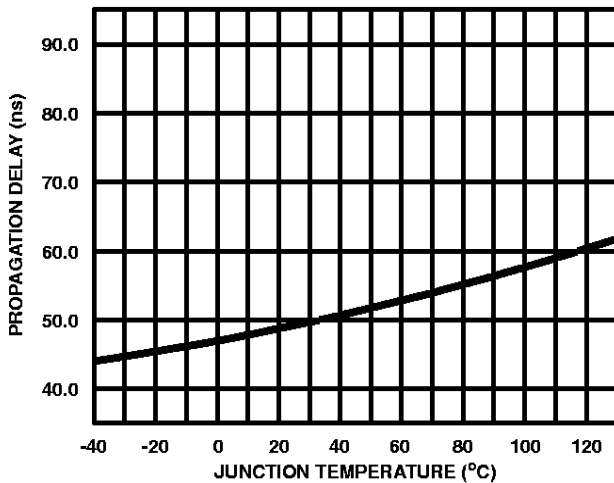


FIGURE 18. UPPER TURN-OFF PROPAGATION DELAY T_{HPLH} vs TEMPERATURE

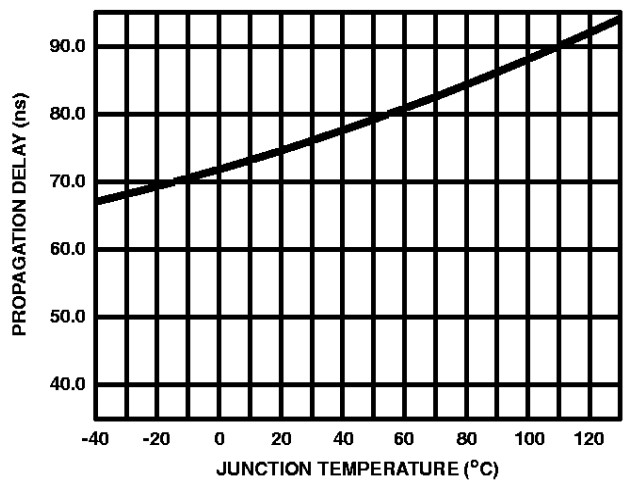


FIGURE 19. UPPER TURN-ON PROPAGATION DELAY T_{HPLH} vs TEMPERATURE

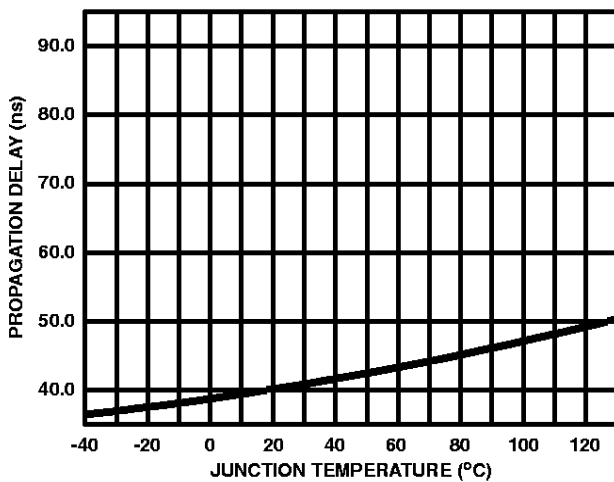


FIGURE 20. LOWER TURN-OFF PROPAGATION DELAY T_{LPHL} vs TEMPERATURE

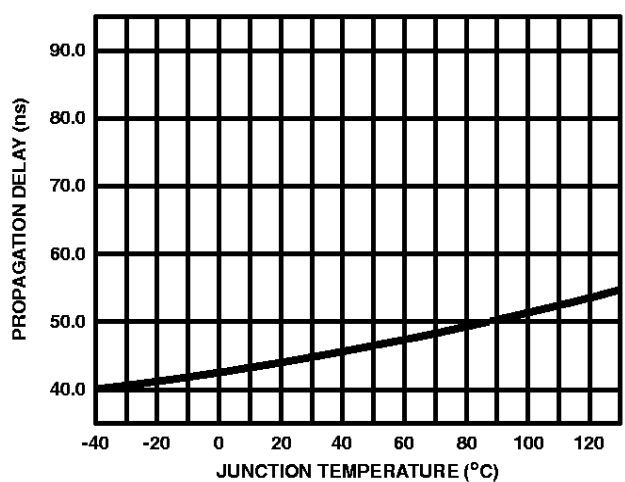


FIGURE 21. LOWER TURN-ON PROPAGATION DELAY T_{LPLH} vs TEMPERATURE

HIP4080A

Typical Performance Curves $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 100K$, and $T_A = +25^\circ C$, Unless Otherwise Specified

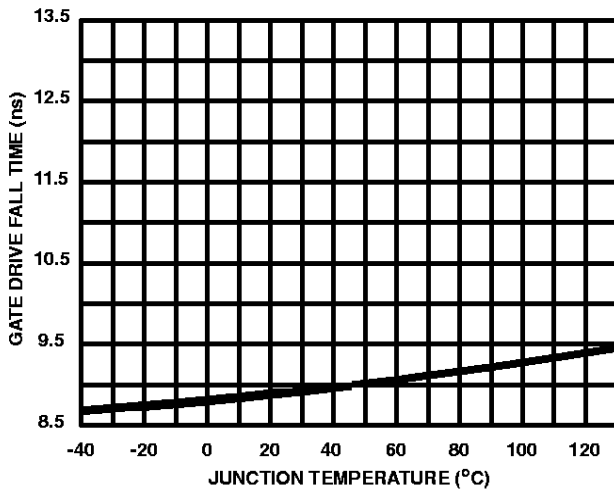


FIGURE 22. GATE DRIVE FALL TIME T_F vs TEMPERATURE

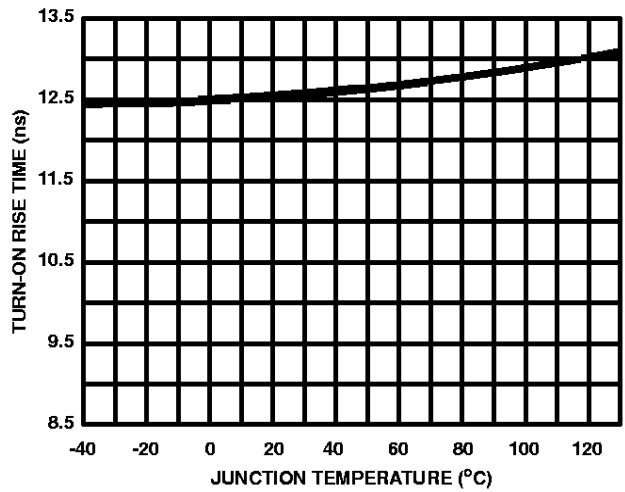


FIGURE 23. GATE DRIVE RISE TIME T_R vs TEMPERATURE

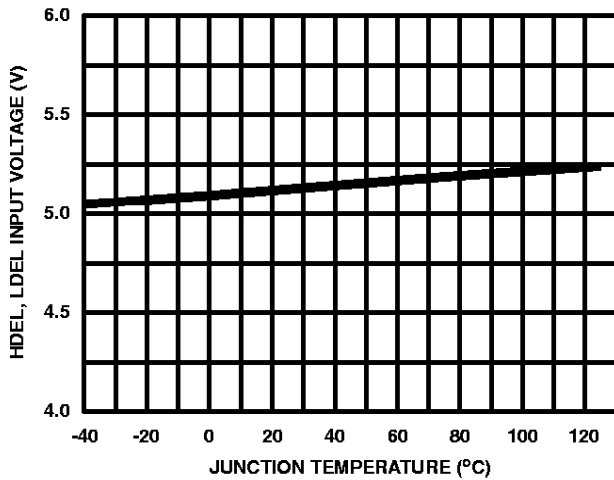


FIGURE 24. V_{LDEL} , V_{HDEL} VOLTAGE vs TEMPERATURE

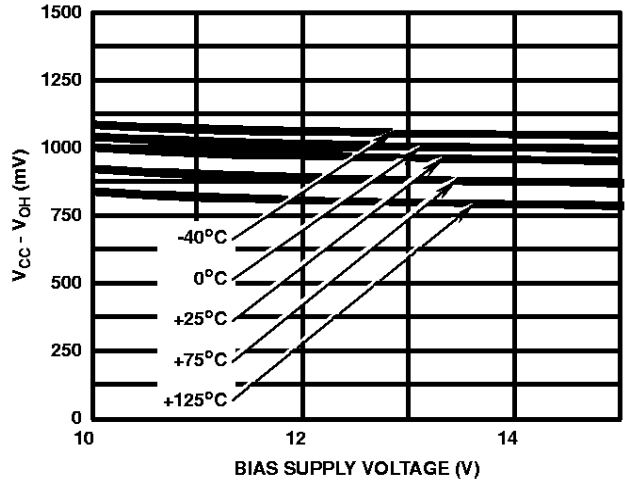


FIGURE 25. HIGH LEVEL OUTPUT VOLTAGE, $V_{CC} - V_{OH}$ vs BIAS SUPPLY AND TEMPERATURE AT $100\mu A$

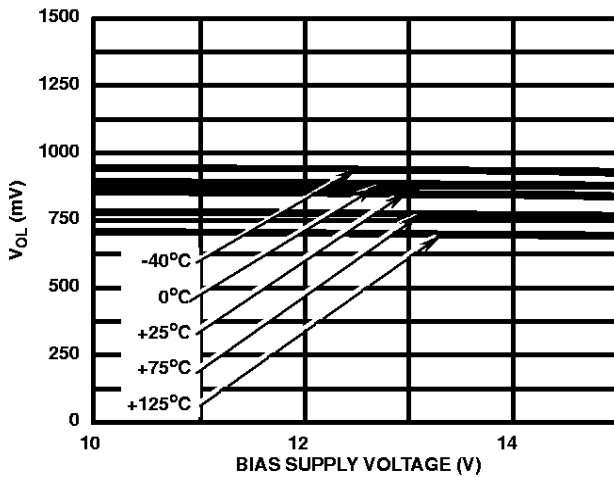


FIGURE 26. LOW LEVEL OUTPUT VOLTAGE V_{OL} vs BIAS SUPPLY AND TEMPERATURE AT $100\mu A$

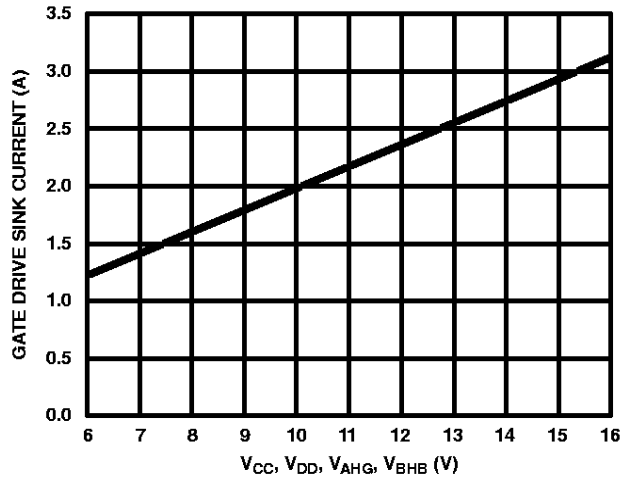


FIGURE 27. PEAK PULLDOWN CURRENT I_O . BIAS SUPPLY VOLTAGE

HIP4080A

Typical Performance Curves $V_{DD} = V_{CC} = V_{AHB} = V_{BHB} = 12V$, $V_{SS} = V_{ALS} = V_{BLS} = V_{AHS} = V_{BHS} = 0V$, $R_{HDEL} = R_{LDEL} = 100K$, and $T_A = +25^\circ C$, Unless Otherwise Specified (Continued)

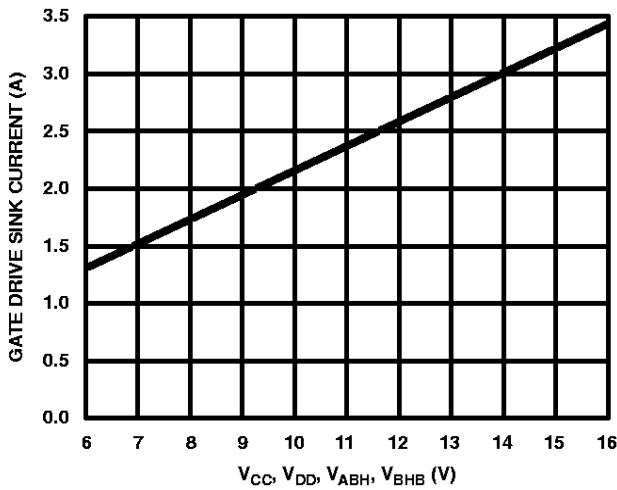


FIGURE 28. PEAK PULLUP CURRENT I_{O+} vs SUPPLY VOLTAGE

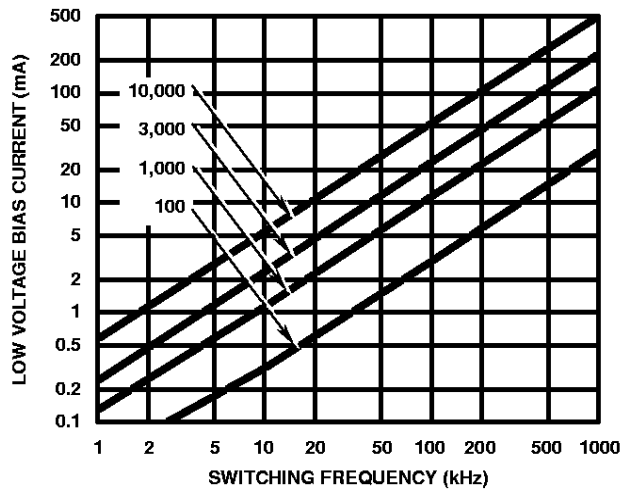


FIGURE 29. LOW VOLTAGE BIAS CURRENT I_{DD} AND I_{CC} (LESS QUIESCENT COMPONENT) vs FREQUENCY AND GATE LOAD CAPACITANCE

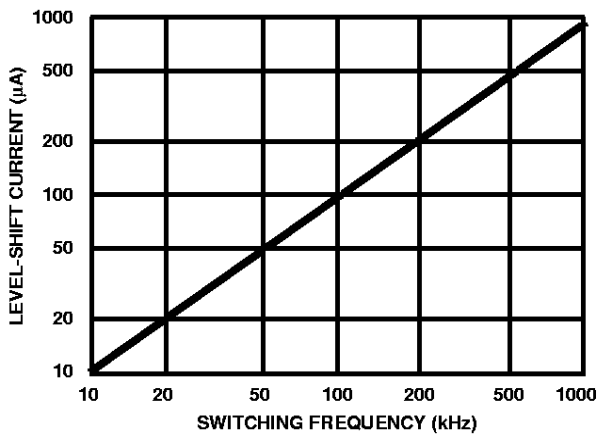


FIGURE 30. HIGH VOLTAGE LEVEL-SHIFT CURRENT vs FREQUENCY AND BUS VOLTAGE

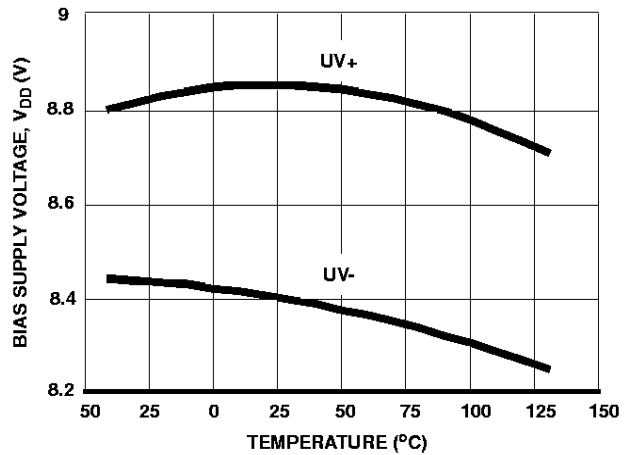


FIGURE 31. UNDERVOLTAGE LOCKOUT vs TEMPERATURE

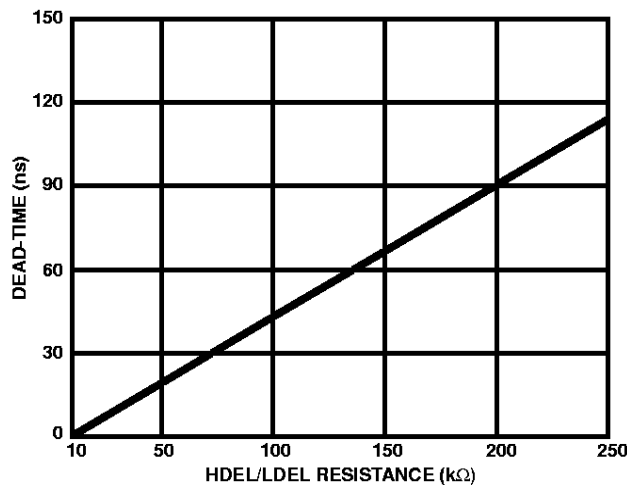
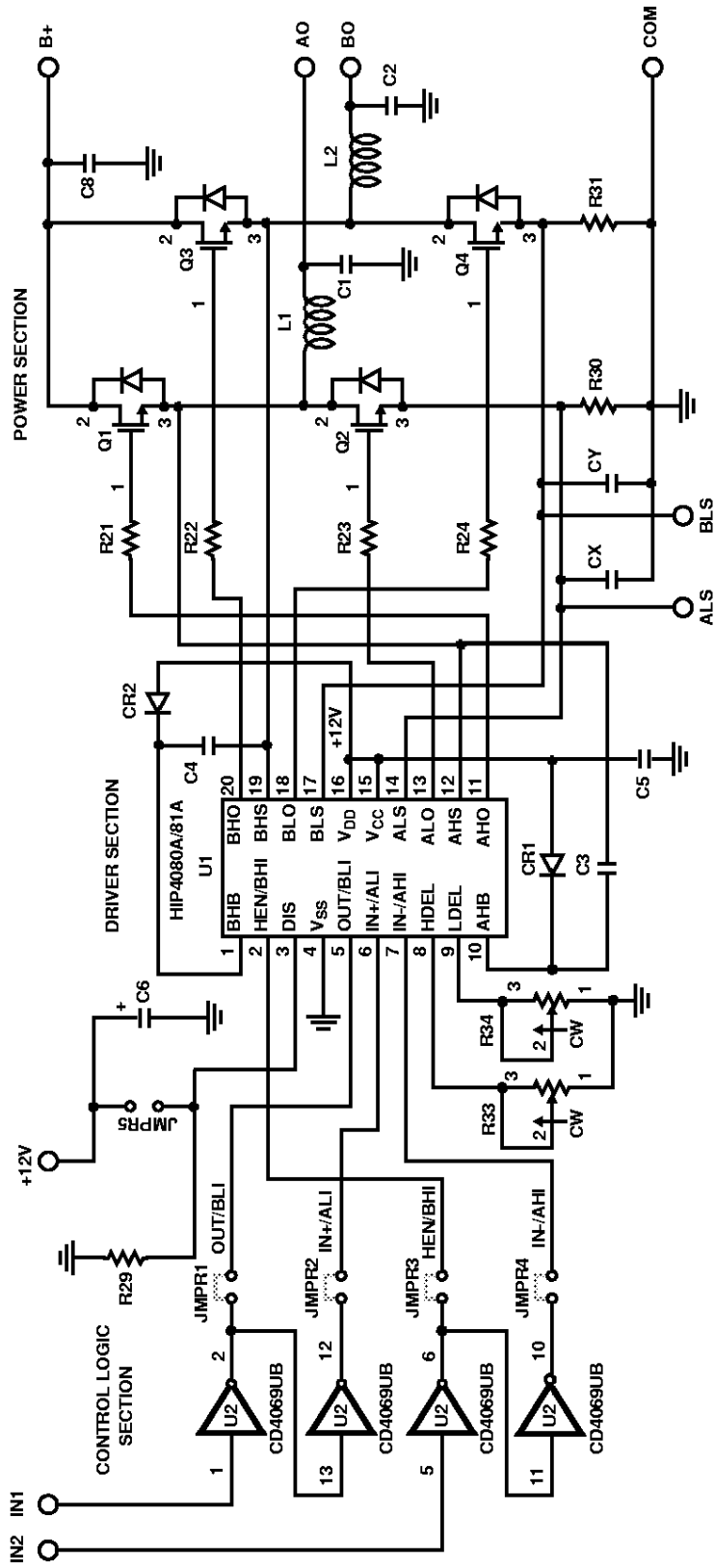


FIGURE 32. MINIMUM DEAD-TIME vs DEL RESISTANCE

HIP4080A



NOTES:

1. DEVICE CD4069UB PIN 7 = COM. PIN 14 = +12V.
2. COMPONENTS L1, L2, C1, C2, CX, CY, R30, R31, ARE NOT SUPPLIED. REFER TO APPLICATION NOTE FOR HELP IN DETERMINING JMPR1 - JMPR4 JUMPER LOCATIONS.

FIGURE 33. HIP4080A EVALUATION PC BOARD SCHEMATIC

HIP4080A

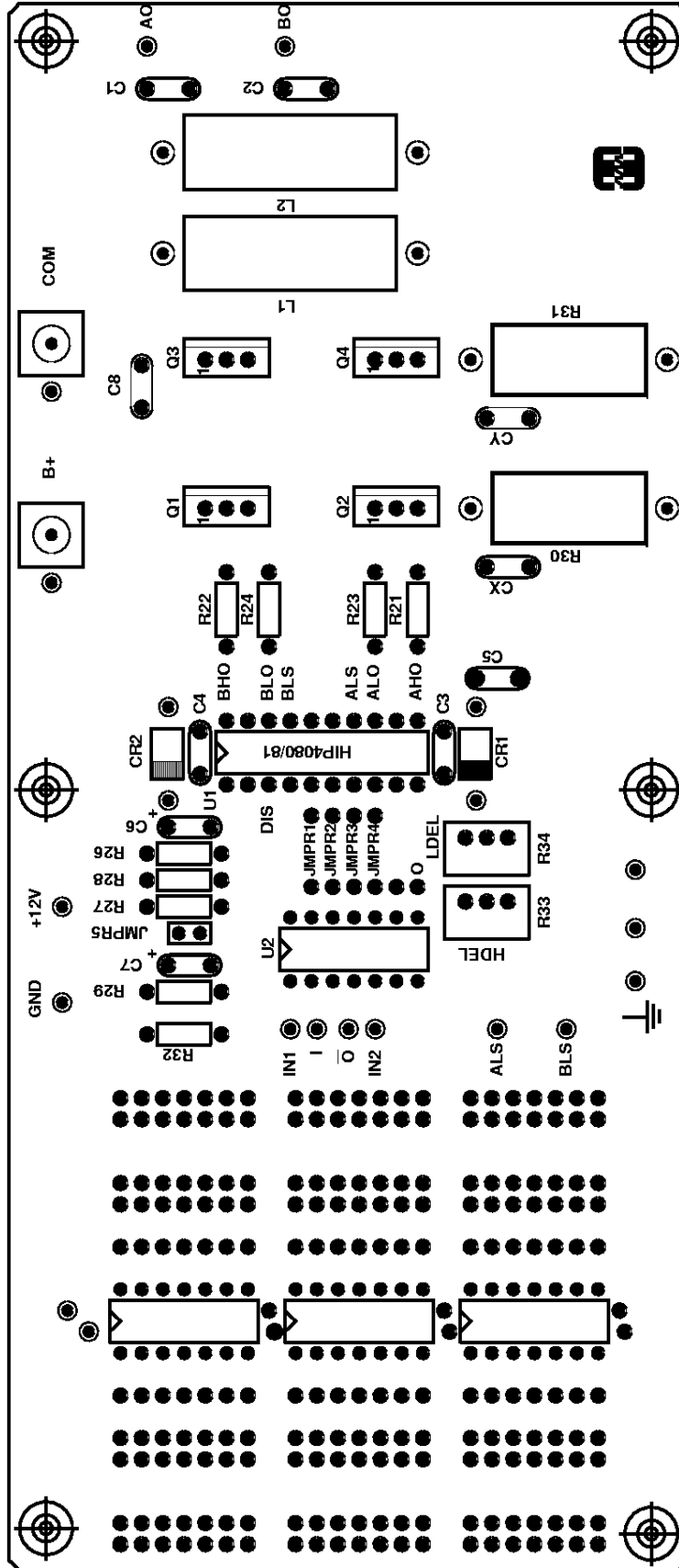
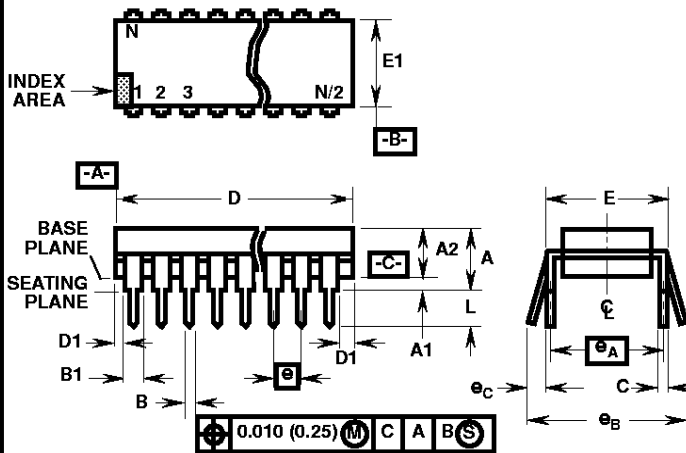


FIGURE 34. HIP4080A EVALUATION BOARD SILKSCREEN

Dual-In-Line Plastic Packages (PDIP)



E20.3 (JEDEC MS-001-AD ISSUE D)
20 LEAD DUAL-IN-LINE PLASTIC PACKAGE

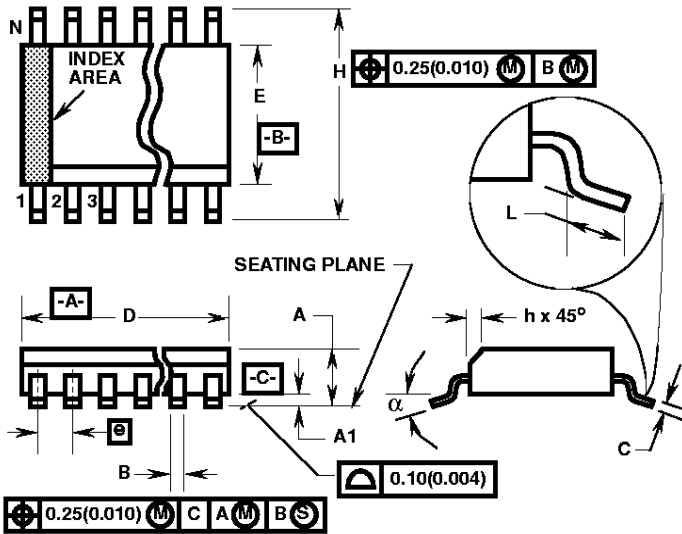
| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|----------------|-----------|-------|-------------|-------|-------|
| | MIN | MAX | MIN | MAX | |
| A | - | 0.210 | - | 5.33 | 4 |
| A1 | 0.015 | - | 0.39 | - | 4 |
| A2 | 0.115 | 0.195 | 2.93 | 4.95 | - |
| B | 0.014 | 0.022 | 0.356 | 0.558 | - |
| B1 | 0.045 | 0.070 | 1.55 | 1.77 | 8 |
| C | 0.008 | 0.014 | 0.204 | 0.355 | - |
| D | 0.980 | 1.060 | 24.89 | 26.9 | 5 |
| D1 | 0.005 | - | 0.13 | - | 5 |
| E | 0.300 | 0.325 | 7.62 | 8.25 | 6 |
| E1 | 0.240 | 0.280 | 6.10 | 7.11 | 5 |
| e | 0.100 BSC | | 2.54 BSC | | - |
| e _A | 0.300 BSC | | 7.62 BSC | | 6 |
| e _B | - | 0.430 | - | 10.92 | 7 |
| L | 0.115 | 0.150 | 2.93 | 3.81 | 4 |
| N | 20 | | 20 | | 9 |

NOTES:

- Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
- Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
- D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
- E and e_A are measured with the leads constrained to be perpendicular to datum -C-.
- e_B and e_C are measured at the lead tips with the leads unconstrained. e_C must be zero or greater.
- B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
- N is the maximum number of terminal positions.
- Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

Rev. 0 12/93

Small Outline Plastic Packages (SOIC)



**M20.3 (JEDEC MS-013-AC ISSUE C)
20 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE**

| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|--------|-----------|--------|-------------|-------|-------|
| | MIN | MAX | MIN | MAX | |
| A | 0.0926 | 0.1043 | 2.35 | 2.65 | - |
| A1 | 0.0040 | 0.0118 | 0.10 | 0.30 | - |
| B | 0.013 | 0.0200 | 0.33 | 0.51 | 9 |
| C | 0.0091 | 0.0125 | 0.23 | 0.32 | - |
| D | 0.4961 | 0.5118 | 12.60 | 13.00 | 3 |
| E | 0.2914 | 0.2992 | 7.40 | 7.60 | 4 |
| e | 0.050 BSC | | 1.27 BSC | | - |
| H | 0.394 | 0.419 | 10.00 | 10.65 | - |
| h | 0.010 | 0.029 | 0.25 | 0.75 | 5 |
| L | 0.016 | 0.050 | 0.40 | 1.27 | 6 |
| N | 20 | | 20 | | 7 |
| α | 0° | 8° | 0° | 8° | - |

NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch)
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

Rev. 0 12/93

Harris Semiconductor products are sold by description only. Harris Semiconductor reserves the right to make changes in circuit design and/or specifications at any time without notice. Accordingly, the reader is cautioned to verify that data sheets are current before placing orders. Information furnished by Harris is believed to be accurate and reliable. However, no responsibility is assumed by Harris or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Harris or its subsidiaries.

Sales Office Headquarters

For general information regarding Harris Semiconductor and its products, call **1-800-4-HARRIS**

UNITED STATES

Harris Semiconductor
P. O. Box 883, Mail Stop 53-210
Melbourne, FL 32902
TEL: 1-800-442-7747
(407) 729-4984
FAX: (407) 729-5321

EUROPE

Harris Semiconductor
Mercure Center
100, Rue de la Fusee
1130 Brussels, Belgium
TEL: (32) 2-724-2111

SOUTH ASIA

Harris Semiconductor H.K. Ltd.
13/F Fourseas Building
208-212 Nathan Road
Tsimshatsui, Kowloon
Hong Kong
TEL: (852) 723-6339

NORTH ASIA

Harris K.K.
Kojimachi-Nakata Bldg. 4F
5-3-5 Kojimachi
Chiyoda-ku, Tokyo 102 Japan
TEL: (81) 3-3265-7571
TEL: (81) 3-3265-7572 (Sales)

